

ATTORNEY DOCKET NO.: V.W. RYAN 16-2



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Vivian W. Ryan, *et al.*

Serial No.: 09/604,519

Filed: June 27, 2000

For: AN INTEGRATED CIRCUIT AND A METHOD OF
MANUFACTURING AN INTEGRATED CIRCUIT

Group No.: 2814

Examiner: D. Graybill

Commissioner for Patents
Washington, D. C. 20231

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Sir:

PRELIMINARY AMENDMENT

Before examination of the above-identified application, please amend it as follows:

IN THE CLAIMS:

(1) Please rewrite Claim 1 as follows:

1. (Twice amended) An integrated circuit comprising:
- a substrate;
 - a plurality of bond pads formed above the substrate; and

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T. BELL.
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